LQ035Q7DB03 TFT LCD Module

(Model No.: LQ035Q7DB03)

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DEVICE SPECIFICATION FOR

TFT-LCD module

MODEL No. LQ035Q7DB03

☐ CUSTOMER'S	S APPROVAL
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PRESENTED

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(1) Application

This literature applies to LQ035Q7DB03.

(2) Overview

This module is a color reflective and active matrix LCD module incorporating amorphous silicon TFT (Thin Film Transistor), named AD-TFT(Advanced TFT). It is composed of a color TFT-LCD panel, driver ICs, an FPC, a back light and a back sealed casing. It isn't composed control circuit. Graphics and texts can be displayed on a $240 \times 3 \times 320$ dots panel with 262,144 colors by supplying.

Optimum view angle is 6 o'clock. An inverted display mode is selective in the vertical or the horizontal direction.

(3) Mechanical specifications

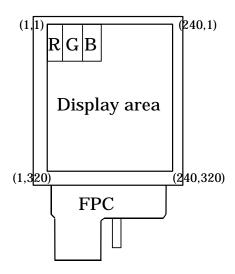
Table 1

Parameter	Specifications	Units	Remarks
Screen size (Diagonal)	8.9 [3.52"] Diagonal	cm	
Display active area	53.64 (H) ×71.52 (V)	mm	
Pixel format	240(H)×320(V)	pixels	
	(1 pixel = R+G+B dots)		
Pixel pitch	0.2235~(H)~ imes 0.2235~(V)	mm	
Pixel configuration	R,G,B vertical stripe		
Unit outline dimension	$65.0(W) \times 85.0(H) \times 3.4$ (D)	mm	[Note3-1]
Mass	40	g	TYP.
Surface hardness	3H		

[Note 3-1]

Excluding protrusion. For detailed measurements and tolerances, please refer to Fig. 1.

(4)Pixel configuration





(5)Input/Output terminal

5-1)TFT-LCD panel driving section

Table2

Pin No.	Symbol	I/O	Description	Remarks
1	VDD	_	Power supply of gate driver(high level)	
2	AGND	_		
3	MOD	I	Control signal of gate driver	[Note5-1]
4	MOD	I	Control signal of gate driver	[Note5-1]
5	U/L	I	Selection for vertical scanning direction	[Note5-2]
6	SPS	I	Start signal of gate driver	
7	CLS	I	Clock signal of gate driver	
8	AGND		Clock Signal of gate writer	
9	VEE	_	Power supply of gate driver(low level)	
10	VEE	_	Power supply of gate driver(low level)	
11	VCOM	I	Common electrode driving signal	
12	VCOM	I	Common electrode driving signal	
13	SPL	I/O	Sampling start signal	
14	R0	I	RED data signal(LSB)	
15	R1	I	RED data signal	
16	R2	I	RED data signal	
17	R3	I	RED data signal	
18	R4	I	RED data signal	
19	R5	I	RED data signal(MSB)	
20	G0	I	GREEN data signal(LSB)	
21	G1	I	GREEN data signal	
22	G2	I	GREEN data signal	
23	G3	I	GREEN data signal	
24	G4	I	GREEN data signal	
25	G5	I	GREEN data signal(MSB)	
26	В0	I	BLUE data signal(LSB)	
27	B1	I	BLUE data signal	
28	B2	I	BLUE data signal	
29	В3	I	BLUE data signal	
30	B4	I	BLUE data signal	
31	В5	I	BLUE data signal(MSB)	
32	VSHD	_	Power supply of digital	
33	DGND	_	Ground(digital)	
34	PS	I	Power save signal	
			(Please don't carry out use by "Low" fixation)	
35	LP	I	Data latch signal of source driver	
36	DCLK	I	Data sampling clock signal	
37	LBR	I	Selection for horizontal scanning direction	[Note5-3]
38	SPR	I/O	Sampling start signal	
39	VSHA	_	Power supply(analog)	



Pin No.	Symbol	I/O	Description	Remarks
40	AGND	1		
41	AGND	_		
42	REV	I	reverse control signal	
43	COM	0	Produce REV signal with the amplitude of AGND-VSHA	
44	AGND	-		
45	AGND	-		
46	AGND	-		
47	AGND			
48	AGND			
49	AGND			
50	AGND		Ground(Analog)	

[Note5-1] See section(7-1)-(A) "%Cautions when you turn on or off the power supply".

[Note5-2] Selection for vertical scanning direction

	0
U/L	Scanning direction (Pixel configuration)
Low	Normal scanning (X, 1)
	\
	(X, 320)
High	Inverted scanning (X, 1)
	<u> </u>
	(X, 320)

[Note5-3] Selection for horizontal scanning direction

LBR	SPL	SPR	Scanning direction (Pixel configuration)
High	Input	Output	Normal scanning $(1,Y) \rightarrow (240,Y)$
Low	Output	Input	Inverted scanning $(1,Y) \leftarrow (240,Y)$

5-2)Back light driving section

Table3

Pin No.	Symbol	I/O	Description	Remark
1	VL1	I	Power supply for LED (High voltage)	
2	N.C			
3	N.C	_	_	
4	VL2	I	Power supply for LED (Low voltage)	
5	N.C	_	-	



(6) Absolute Maximum Ratings

Table 4

Parameter	Symbol	Condition	Ratings	Unit	Remark
Power supply(source/Analog)	VSHA	Ta=25℃	-0.3∼+7.0	V	
Power supply(source/Digital)	VSHD	Ta=25℃	-0.3~+7.0	V	
Power supply (gate)	VDD	Ta=25℃	-0.3∼+35.0	V	
Power supply (gate)	VDD-VEE	Ta=25℃	-0.3∼+35.0	V	
Input voltage (Digital)	VID	Ta=25℃	-0.3∼VSHD+0.3	V	[Terminal 1]
Operating temperature (panel surface)	Торр	_	-10~60	$^{\circ}$	[Note6]
Storage temperature	T stg	_	-25~70	$^{\circ}$ C	[Note6-2]

[Note6-2] Humidity: 95%RH Max.(at $Ta \le 40^{\circ}$ C). Maximum wet-bulb temperature is less than 39°C (at $Ta > 40^{\circ}$ C). Condensation of dew must be avoided.



- (7) Electrical characteristics
- 7-1)Recommended operating conditions
- A) TFT-LCD panel driving section

Table 5 GND=0V

		1.	able 5				GND=0
Para	Symbol	Min.	Тур.	Max.	Unit	Remarks	
Supply voltage for	VSHA	+4.5	+5.0	+5.5	V		
(Analog)							
Supply voltage for	source driver	VSHD	+3.0	+3.3	+3.6	V	
(Digital)							
Supply voltage	High voltage	VDD	+14.5	+15.0	+15.5	V	
for gate driver							
	Low voltage	VEE	-10.5	-10.0	-9.5	V	
Input voltage for S	ource driver (Low)	VILS	GND	-	0.2VSHD	V	[Note 7-1]
Input voltage for So	ource driver (High)	VIHS	0.8VSHD	-	VSHD	V	[Note 7-1]
Input current for S	Source driver (Low)	IILS	-	-	30	μ A	[Note 7-1]
Instruct comment for C	dui (I Ii ala)	IIHS1	-	-	30	μΑ	[Note 7-2]
Input current for So	ource ariver (High)	IIHS2	-	-	1200	μ A	[Note 7-3]
Input voltage for G	ate driver (Low)	VILG	GND	-	0.2VSHD	V	[Note 7-4]
Input voltage for G	ate driver (High)	VIHG	0.8VSHD	-	VSHD	V	[Note 7-4]
Input current for C	IILG	-	-	4	μ A	[Note 7-4]	
Input current for C	IIHG	-	-	4	μΑ	[Note 7-4]	
Common electrode	AC component	VCOMAC	-	± 2.5	± 2.6	Vp-p	[Note 7-5]
driving signal	DC component	VCOMDC	-0.4	+0.6	+1.6	V	[Note 7-5]

- Cautions when you turn on or off the power supply
 - ① Turn on or off the power supply with simultaneously or the following sequence.

Turn on
$$\cdots$$
 VSHD \rightarrow VSHA \rightarrow VEE \rightarrow VDD
Turn off \cdots VDD \rightarrow VEE \rightarrow VSHA \rightarrow VSHD

- ② The input signal of "MOD" Terminals(Pin No.3 and No.4) must be low voltage when turning on the power supply, and it is held until more than double vertical periods after VCC is turned on completely. After then, it must be held high voltage until turning off the power supply.(Connect Pin No.3 and No.4 terminals to the same signal.)
- [Note 7-1] DCLK,SPL,SPR,LBR,LP,PS,REV,R0~R5,G0~G5 and B0~B5 terminals are applied.
- [Note 7-2] DCLK,SPL,SPR,LBR,LP,REV,R0~R5,G0~G5 and B0~B5 terminals are applied.
- [Note 7-3] PS terminal is applied.
- [Note 7-4] MOD, CLS, SPS and U/L terminals are applied.
- [Note 7-5] VCOMAC should be alternated on VCOMDC every 1 horizontal period and 1 vertical period. VCOMDC bias is adjusted so as to minimize flicker or maximum contrast every each module.

B) Back light driving section

Table 6 Ta= 25° C

Parameter	Symbol	MIN	TYP	MAX	Units	Remarks terminal
LED voltage	VL		21.6	24	V	
LED current	IL		15	20	m A	
Power consumption	WL	_	0.324	_	W	[Note 7-6]

[Note 7-6] Calculated reference value(IL×VL)



7-2) Timing Characteristics of input signals

Table 7 AC Characteristics (1)

(VSHA=+5V, VSHD=+3.3V, Ta=25°C)

Daramete	Parameter		Min.	Тур.	Max.	Unit	Remark
		Symbol		1.ур.			Remark
Clock fre	quency of source driver	fCK	4.5 —	_	6.8	MHz	
	Rising time of clock	Tcr		_	20	ns	D 07 77
	Falling time of clock	Tcf	_	_	20	ns	DCLK
	Pulse width (High level)	Tcwh	40	_	_	ns	
	Pulse width (Low level)	Tcwl	40	_	_	ns	
	Frequency of start pulse	fsp	16.5	_	28	kHz	
Source	Setup time of start pulse	Tsusp	15	_	_	ns	SPL,SPR
driver	Hold time of start pulse	Thsp	10	_	_	ns	_
uriver	Pulse width of start pulse	Twsp	_	_	1.5/fck	ns	[Note 7-7]
	Setup time of latch pulse	Tsulp	20	_	_	ns	
	Hold time of latch pulse	Thlp	20	_	_	ns	LP
	Pulse width of latch pulse	Twlp	60	_	_	ns	
	Setup time of PS	Tsups	0	_	59	μs	DC
	Hold time of PS		0	_	1	μs	PS
Set up tir	ne of data	Tsud	15	_	_	ns	R0~R5,G0~G5
Hold time	e of data	Thd	10	_	_	ns	,B0∼B5
	Clock frequency	fcls	16.5	_	28	kHz	
	Pulse width of clock(Low)	Twlcls	5	_	(1/fclk)-30	μs	
	Pulse width of clock(High)	Twhcls	30	_	_	μs	
	Rising time of clock	Trcls	-	_	100	ns	CLS
	Falling time of clock	Tfcls	_	_	100	ns	
Gate	Setup time of clock	Tsucls	3	_	_	μs	
driver	Hold time of clock	Thcls	0	_	_	μs	
	Frequency of start pulse	fsps	50	_	86	Hz	
	Setup time of start pulse	Tsu	100	_	_	ns	
	Hold time of start pulse	Th	300	_	_	ns	SPS
	Rising time of start pulse	Trsp	_	_	100	ns	
	Falling time of start pulse	Tfsp	_	_	100	ns	
Vcom	Setup time of Vcom	Tsuvcom	3	_	_	μs	Vcom
	Hold time of Vcom	Thycom	1	_	_	μs	

[Note 7-7] There must be only one up-edge of DCLK (includes Tsusp and Thsp time) in the period of SPL="Hi".

Fig.(a) Horizontal timing chart

Fig.(b) Vertical timing chart



7-3)Power consumption

 $Measurement\ condition: SPS=60Hz, CLS=15.73kHz, SPL=15.73kHz, DCLK=6.3MHz$

The term of PS="Lo" in one horizontal period $\,\cdots\,$ 37 $\mu\,$ sec(234DCLK)

Ta=25°C

Table 8

when normal scan mode

Parameter		Sym	Conditions	MIN	TYP	MAX	Unit	Remarks
Source	Analog	ISHA	VSHA=+5.0V	_	3.0	6.5	mA	[Note 7-8]
current	Digital	ISHD	VSHD=+3.3V	_	2.0	3.5	mA	[Note 7-8]
Gate	High	IDD	VDD=+15.0V	_	0.05	0.10	mA	[Note 7-9]
current	Low	IEE	VEE=-10.0V	1	-0.05	-0.10	mA	[Note 7-9]

[Note 7-8] Vertical stripe pattern alternating 21 gray scale (GS21) with 42 gray scale (GS42) every 1 dot. [Note 7-9] 64-Gray-bar vertical pattern (GS0 \sim GS63 for horizontal way)



 $(\,8\,) Input \ Signals, \ Basic \ Display \ Color \ and \ Gray \ Scale \ of \ Each \ Color$

Table 9

ı	Table 9																			
	Colors &						Da	ıta siş	gnal						1					
	Gray scale	Gray	R0	R1	R2	R3	R4	R5	G0	G1	G2	G3	G4	G5	В0	B1	B2	В3	B4	B5
		Scale																		
	Black	_	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue	_	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
В	Green	_	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
asic	Cyan	_	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
Basic color	Red	_	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
r	Magenta	_	1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	_	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	_	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	仓	GS1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale of red	Darker	GS2	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Sca	仓	\downarrow			1	/					V	l						V		
le o	Û	\downarrow			1	/						<u> </u>						V		
f red	Brighter	GS61	1	0	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Û	GS62	0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red	GS63	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
$G_{\mathbb{F}}$	仓	GS1	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0
Gray Scale of green	Darker	GS2	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0
Scal	仓	\downarrow			1	\					V	l						V		
e of	Û	\downarrow			1	/						<u> </u>						V		
gree	Brighter	GS61	0	0	0	0	0	0	1	0	1	1	1	1	0	0	0	0	0	0
n	Û	GS62	0	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0
	Green	GS63	0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Black	GS0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
0	仓	GS1	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
ray	Darker	GS2	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0
Sca	仓	\rightarrow	V					V				↓								
le of	Û	\rightarrow			1	/			\					V						
Gray Scale of bleu	Brighter	GS61	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	1	1	1
1	Û	GS62	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
	Bleu	GS63	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

0:Low level voltage

1 :High level voltage

Each basic color can be displayed in 64 gray scales from 6 bit data signals. According to the combination of total 18 bit data signals, the 262,144-color display can be achieved on the screen.



(9)Optical characteristics

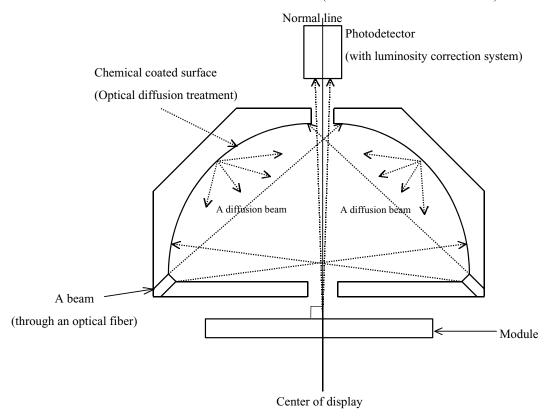
9-1)Not driving the Back light condition

Table 10 Ta=25°C

Table 10			1a 25 C					23 C
Parameter		Symbol	Condition	Min	Тур	Max	Unit	Remarks
Viewing angle		θ21,22		35	50	-	degree	[Note 9-1,2]
range		θ11	CR≥2	35	50	-	degree	
		θ12		35	50	-	degree	
Contrast ratio		CRmax	θ =0°	6	15	-		[Note 9-2,4]
Response	Rise	τr		-	30	60	ms	[Note 9-3]
time	Fall	τd	0.00	-	50	100	ms	
White chromaticity		X	$\theta = 0_{\circ}$	0.26	0.31	0.36		[Note 9-4]
		у		0.29	0.34	0.39		
Reflection ratio		R	$\theta = 0_{\circ}$	8	13	-	%	[Note 9-5]

^{*} The measuring method of the optical characteristics is shown by the following figure.

^{*} A measurement device is Otsuka luminance meter LCD5000.(With the diffusion reflection unit.)



Measuring method (a) for optical characteristics



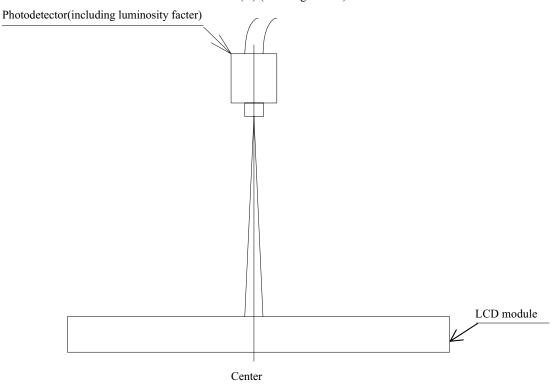
9-2)Driving the Back light condition

Table 11	Ta=25°C

Parameter		Symbol	Condition	Min	Тур	Max	Unit	Remarks
Viewing angle		θ21,22		30	40	-	degree	[Note 9-1,2,6]
range		θ11	CR≥2	40	50	-	degree	
		θ12		30	40	-	degree	
Contrast ratio		Crmax	$\theta = 0_{\circ}$	55	85	-		[Note 9-2]
Response	Rise	τr		-	30	60	ms	[Note 9-3]
time	Fall	τd		-	50	100	ms	
White chromaticity		X		0.27	0.32	0.37		
		у		0.29	0.34	0.39		
Brightness		Y	$\theta = 0_{\circ}$	_	55	-	(cd/m2)	IL=20mA
LED life tii	ne	LL	IL=15mA	_	10000	_	hour	[Note 9-7]

^{*} The measuring method of the optical characteristics is shown by the following figure.

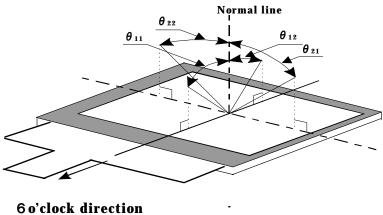
^{*} A measurement device is TOPCON luminance meter BM-5(A).(Viewing cone 1)



Measuring method (c) for optical characteristics



[Note 9-1] Viewing angle range is defined as follows.



Definition for viewing angle

[Note 9-2] Definition of contrast ratio:

The contrast ratio is defined as follows:

Photodetecter output with all pixels white(GS63)

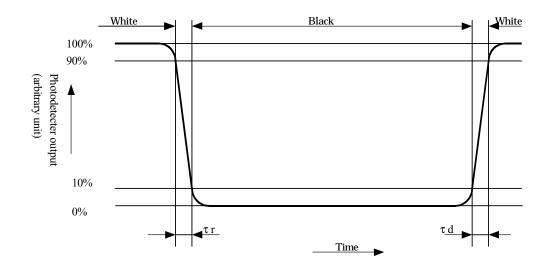
Contrast ratio(CR)=

Photodetecter output with all pixels black(GS0)

VCOMAC=5.0Vp-p

[Note 9-3] Definition of response time:

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".





[Note 9-4] A measurement device is Minolta CM-2002.

[Note 9-5] Definition of reflection ratio Light detected level of the reflection by the LCD module

Reflection ratio = Light detected level of the reflection by the standard white board

[Note 9-6] A measurement device is ELDIM EZContrast

[Note 9-7]This is the reference vlue. The White-LED life time is defind as a time when brightness not to become under 50% of the original value(at Ta=25 $^{\circ}$ C)

(10) Display quality

The display quality of the color TFT-LCD module shall be in compliance with the Incoming Inspection Standards for TFT-LCD..

(11) Mechanical characteristics

11-1) External appearance

See Fig. 1

- 11-2) FPC (for LCD panel) characteristics
 - (1)Specific connector

FH12A-50S-0.5SH(HIROSE)

(2) Bending endurance of the bending slits portion

No line of the FPC is broken for the bending test (Bending radius=0.6mm and angle=90°) in 30 cycles.



(12) Handling Precautions

12-1) Insertion and taking out of FPCs

Be sure insert and take out of the FPC into the connector of the set after turning off the power supply on the set side.

12-2) Handling of FPCs

The FPC for LCD panel shall be bent only slit portion. The bending slit shall be bent uniformly on the whole slit portion with bending radius larger than 0.6mm ,and only inner side (back side of the module). Don't bend it outer side (display surface side).

Don't give the FPCs too large force, for example, hanging the module with holding FPC.

12-3) Installation of the module

On mounting the module, be sure to fix the module on the same plane. Taking care not to warp or twist the module.

12-4)Precaution when mounting

- (1) If water droplets and oil attaches to it for a long time, discoloration and staining occurs. Wipe them off immediately.
- (2) Glass is used for the TFT-LCD panel. If it is dropped or bumped against a hard object, it may be broken. Handle it with sufficient care.
- (3)As the CMOS IC is used in this module, pay attention to static electricity when handling it. Take a measure for grounding on the human body.

12-5)Others

- (1) The liquid-crystal is deteriorated by ultraviolet rays. Do not leave it in direct sunlight and strong ultraviolet rays for many hours.
- (2) If it is kept at a temperature below the rated storage temperature, it becomes coagulated and the panel may be broken. Also, if it is kept at a temperature above the rated storage temperature, it becomes isotropic liquid and does not return to its original state. Therefore, it is desirable to keep it at room temperature as much as possible.
- (3) If the LCD breaks, don't put internal liquid crystal into the mouth. When the liquid crystal sticks to the hands, feet and clothes, wash it out immediately.
- (4) Wipe off water drop or finger grease immediately. Long contact with water may cause discoloration or spots.
- (5) Observe general precautions for all electronic components.
- (6) VCOM must be adjusted on condition of your final product. No adjustment causes the deterioration for display quality.
- (7) Static image should not be displayed more than 5 minutes in order to prevent from occurrence of residual image.



(13) Reliability Test Conditions for TFT-LCD Module

Table 12

No.	Test items	Test conditions
1	High temperature storage test	Ta=+70°C 240h
2	Low temperature storage test	Ta=-25℃ 240h
3	High temperature and high humidity operating test	Tp=+40°C , 95%RH 240h (But no condensation of dew)
4	High temperature operating test	, , , , , , , , , , , , , , , , , , ,
5	Low temperature operating test	Tp=-10°C 240h
6	Electro static discharge test	$\pm 200 \mathrm{V} \cdot 200 \mathrm{pF}(0\Omega)$ 1 time for each terminals
7	Shock tset	980 m/s ² , 6 ms \pm X, \pm Y, \pm Z 3 times for each direction (JIS C0041, A-7 Condition C)
8	Vibration test	Frequency range: 10Hz~55Hz Stroke: 1.5 mm Sweep: 10Hz~55Hz X,Y,Z 2 hours for each direction (total 6 hours) (JIS C0040,A-10 Condition A)
9	Heat shock test	Ta=-25°C \sim +70°C / 5 cycles (1h) (1h)

[Note] Ta = Ambient temperature, Tp = Panel temperature [Check items]

• Test No.1∼9

In the standard condition, there shall be no practical problems that may affect the display function. $\label{eq:problems}$



(14) Others

14-1)Indication of lot number

The lot number is shown on a label. Attached location is shown in Fig.1 (Outline Dimensions).

Indicated contents of the label

LQ035Q7DB03 OOOOOO model No. lot No.

14-2) Used Regulation of Chemical Substances Breaking Ozone Stratum

Substances with the object of regulating: CFCS, Carbon tetrachloride, Halon

1,1,1-Trichloro ethane (Methyl chloroform)

- (a) This LCD module, Constructed part and Parts don't contain the above substances.
- (b) This LCD module, Constructed part and Parts don't contain the above substances in processes of manufacture.
- 14-3) If some problems arise about mentioned items in this document and other items, the user of the TFT-LCD module and Sharp will cooperate and make efforts to solve the problems with mutual respect and good will.

15)Forwarding form

- a) Piling number of cartons: Max 20
- b) Package quality in one cartons: 50pcs
- c) Carton size:503mm x 373mm x 88mm
- d) Total mass of 1 carton filled with full modules: 3 3 0 0 g

Conditions for storage.

Environment

(1)Temperature : $0\sim40^{\circ}$ C

(2) Humidity : 60%RH or less (at 40%)

No dew condensation at low temperature and high humidity.

(3)Atmosphere : Harmful gas, such as acid or alkali which bites electronic

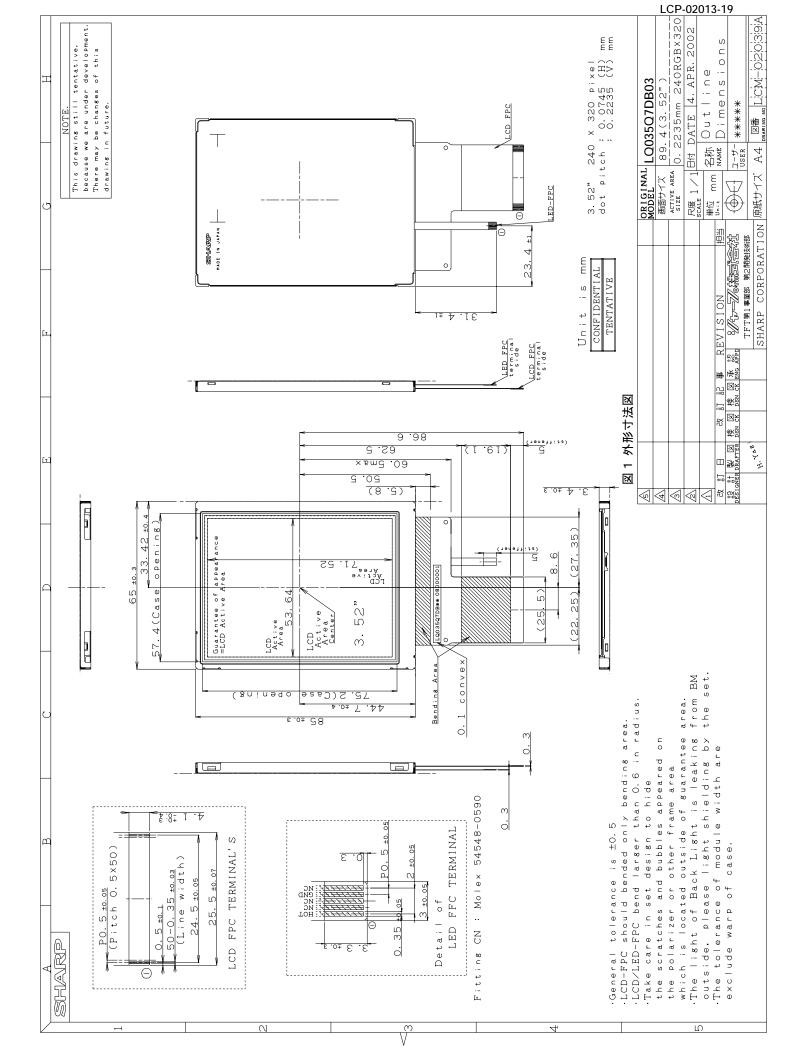
components and/or wires, must not be detected.

(4)Period : about 3 months

(5)Opening of the package : In order to prevent the LCD module from breakdown by

electrostatic charges, please control the room humidity over 50%RH and open the package taking sufficient countermeasures against electrostatic charges, such as

earth, etc.





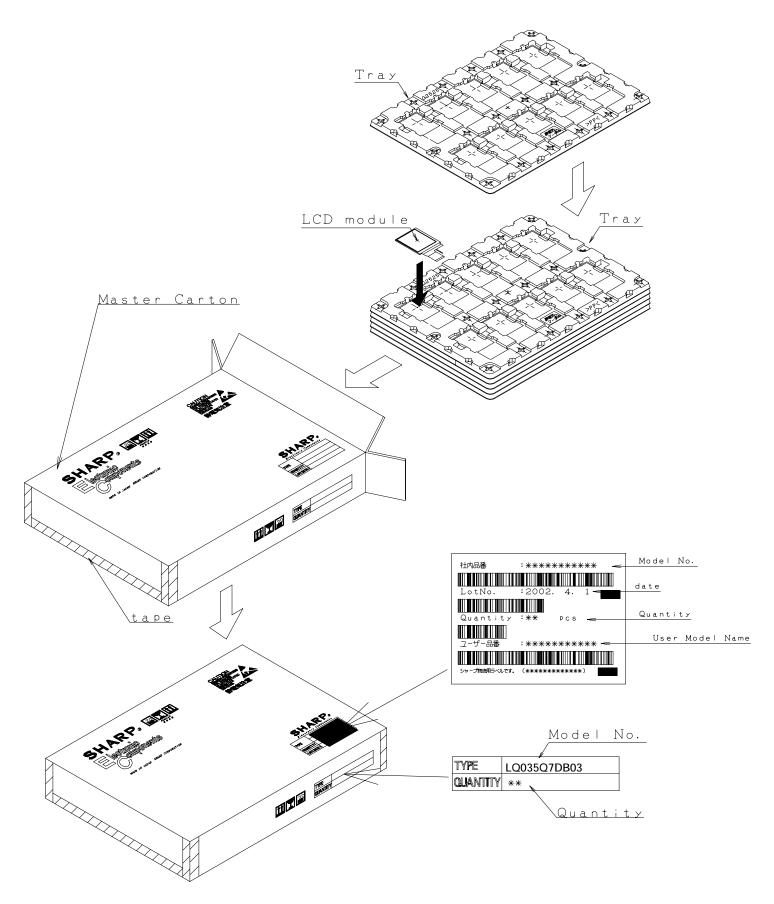


図2 包装形態図

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